IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- 10 µs Short Circuit Capability
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb-Free Devices

Typical Applications

- Solar Inverter
- UPS Inverter

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit			
Collector-emitter voltage	V _{CES}	1200	V			
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	50 25	A			
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	200	A			
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	50 25	A			
Diode pulsed current, T_{pulse} limited by $T_{J\text{max}}$	I _{FM}	200	A			
Gate-emitter voltage	V_{GE}	±20	V			
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	192 77	W			
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, $T_J \leq 150^\circ C$	T _{SC}	10	μS			
Operating junction temperature range	ТJ	-55 to +150	°C			
Storage temperature range	T _{stg}	–55 to +150	°C			
Lead temperature for soldering, 1/8" from case for 5 seconds(note 3)	T _{SLD}	260	°C			

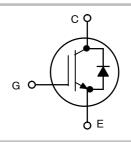
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

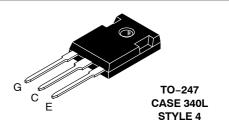


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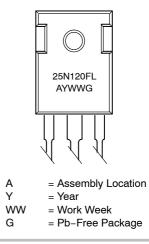
http://onsemi.com

25 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.95 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB25N120FLWG	TO-247 (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

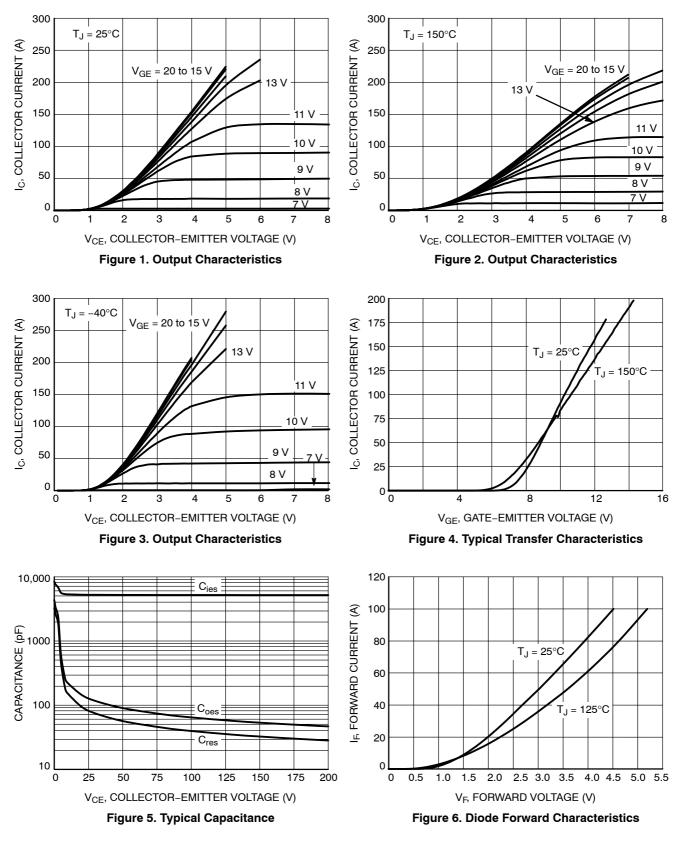
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.65	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

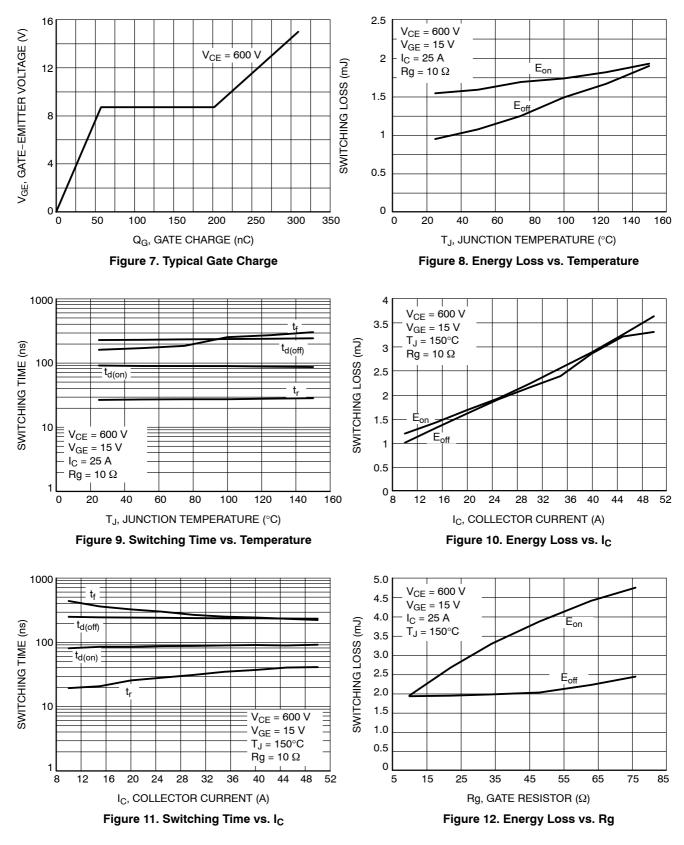
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

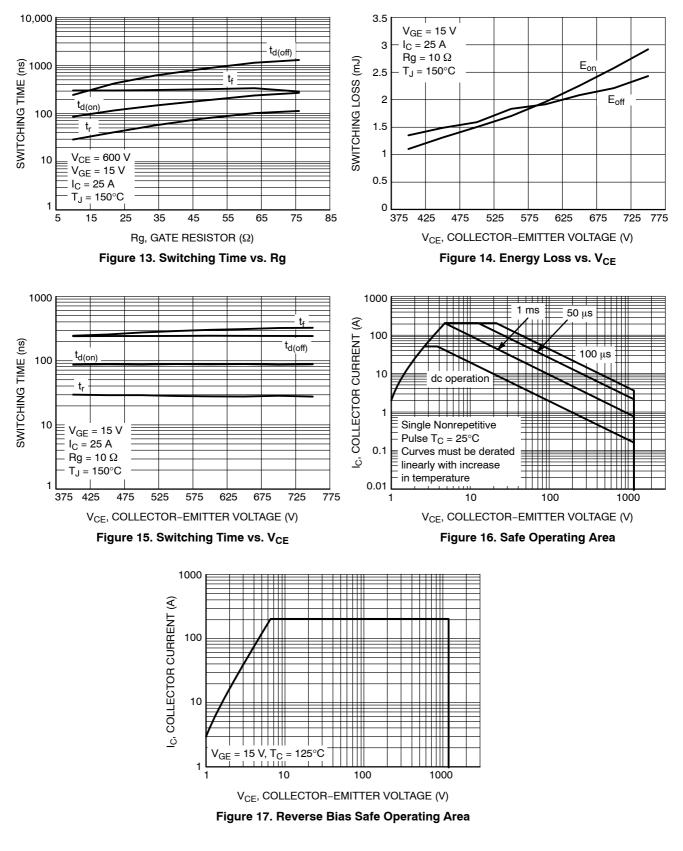
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	1200	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 25 A V_{GE} = 15 V, I _C = 25 A, T _J = 150°C	V _{CEsat}	1.55 -	2.0 2.2	2.2	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 250 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}$ $V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}, \text{ T}_{\text{J}} = 150^{\circ}\text{C}$	I _{CES}			0.5 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	5200	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	144	-	1
Reverse transfer capacitance		C _{res}	-	94	-	
Gate charge total		Qg		220		nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 25 A, V _{GE} = 15 V	Q _{ge}		40		
Gate to collector charge		Q _{gc}		98		
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}		91		ns
Rise time		t _r		26		
Turn-off delay time	T _J = 25°C V _{CC} = 600 V, I _C = 25 A	t _{d(off)}		228		
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{g} = 10 \Omega$	t _f		160		
Turn-on switching loss	V _{GE} = 0 V/ 15V	Eon		1.50		mJ
Turn-off switching loss		E _{off}		0.95		
Total switching loss		E _{ts}		2.45		
Turn-on delay time		t _{d(on)}		88		ns
Rise time		t _r		28		
Turn-off delay time	T _J = 125°C	t _{d(off)}		240		
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{g} = 10 \Omega$	t _f		270		1
Turn-on switching loss	$V_{GE} = 0 V/15V$	E _{on}		1.8		mJ
Turn-off switching loss]	E _{off}		1.6		1
Total switching loss	7	E _{ts}		3.4		

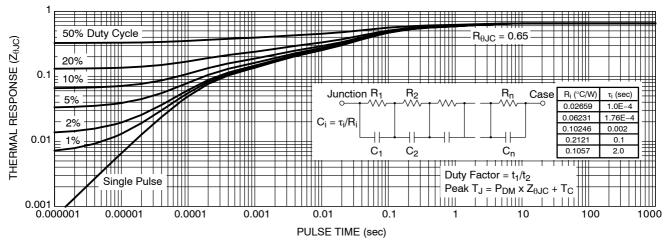
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
DIODE CHARACTERISTIC							
Forward voltage	V_{GE} = 0 V, I _F = 25 A V_{GE} = 0 V, I _F = 25 A, T _J = 150°C	V _F		2.2 2.5	2.8	V	
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}		240		ns	
Reverse recovery charge	I _F = 25 Å, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}		1.5		μο	
Reverse recovery current		I _{rrm}		15		А	
Reverse recovery time	T _J = 125°C	t _{rr}		260		ns	
Reverse recovery charge	I _F = 25 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}		2.0		μο	
Reverse recovery current		I _{rrm}		19		А	











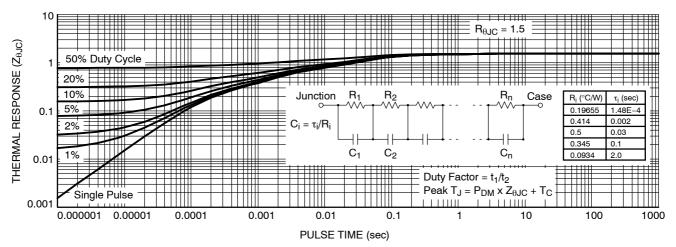


Figure 19. Diode Transient Thermal Impedance

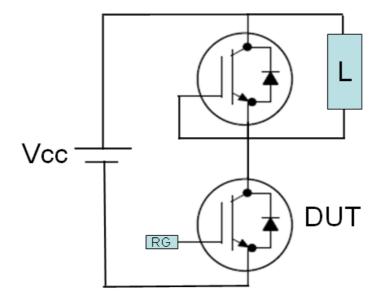
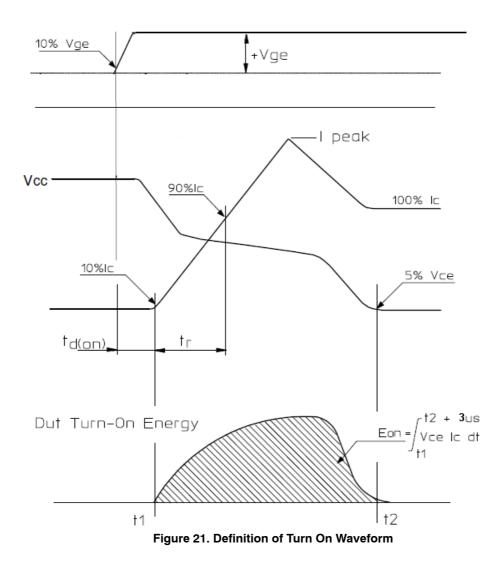
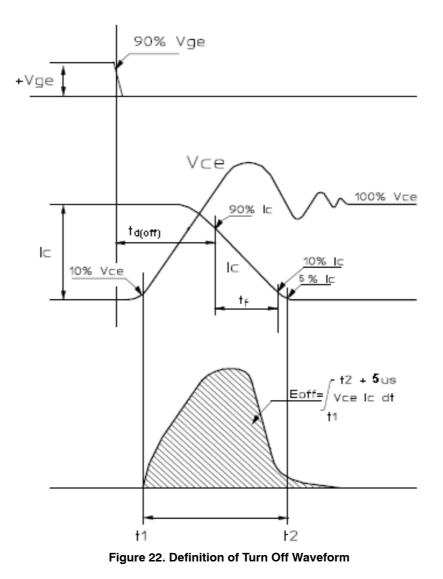


Figure 20. Test Circuit for Switching Characteristics





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TO-247 CASE 340L ISSUE G G SCALE 1:1 Т В EATING -Ν Α 7 . ർറ ∲Ø0.63 (0.025)@|T|B@ Р Ý 2X F G ·H ЗХ D ♦ 0.25 (0.010) W Y AS

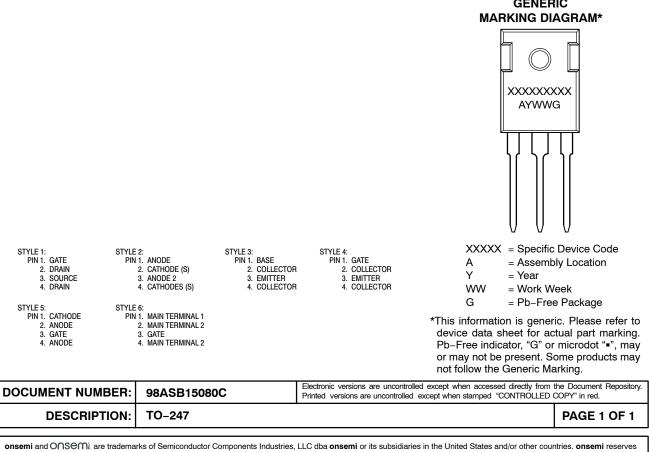
DATE 06 OCT 2021

NOTES

- DIMENSIONING AND TOLERANCING PER ASME 1. Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
A	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242	BSC
W	2.87	3.12	0.113	0.123

GENERIC



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